

## **Description**

The IRLML6346PbF uses advanced trench technology

to provide excellent RDS(ON), low gate charge and

operation with gate voltages as low as 2.5V. This

device is suitable for use as a

Battery protection or in other Switching application.



**SOT-23** 

PIN2 D

#### **General Features**

 $V_{DS} = 30V I_{D} = 5A$ 

 $R_{DS(ON)}$  < 42m $\Omega$  @  $V_{GS}$ =10V

# PIN1 G

N-Channel MOSFET

## **Application**

Battery protection

Load switch

Uninterruptible power supply

#### **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
IRLML6346PbF	SOT-23	HXY MOSFET	3000

## Absolute Maximum Ratings (T<sub>A</sub>=25 ℃ unless otherwise noted)

Parameter	Limit	Unit
Drain-Source Voltage	30	V
Gate-Source Voltage	±12	V
Drain Current-Continuous	5	Α
Drain Current-Pulsed (Note 1)	14.4	А
Maximum Power Dissipation	1	W
Operating Junction and Storage Temperature Range	-55 To 150	°C
Thermal Resistance, Junction-to-Ambient (Note 2)	125	°C/W
	Drain-Source Voltage  Gate-Source Voltage  Drain Current-Continuous  Drain Current-Pulsed (Note 1)  Maximum Power Dissipation  Operating Junction and Storage Temperature Range	Drain-Source Voltage 30  Gate-Source Voltage ±12  Drain Current-Continuous 5  Drain Current-Pulsed (Note 1) 14.4  Maximum Power Dissipation 1  Operating Junction and Storage Temperature Range -55 To 150



## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			<b>V</b>	
Danier	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =3A		33	42		
R <sub>DS(ON)</sub>		V <sub>GS</sub> =4.5V , I <sub>D</sub> =2A	38 48		48	mΩ	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	0.4		1.2	V	
Ipss	Drain-Source Leakage Current	V <sub>DS</sub> =16V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	uA	
IDSS		V <sub>DS</sub> =16V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	uA	
Igss	Gate-Source Leakage Current	$V_{GS}=\pm 12V$ , $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =3A		10.5		S	
Qg	Total Gate Charge (4.5V)			4.6			
Qgs	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =3A		0.7		nC	
$Q_{gd}$	Gate-Drain Charge			1.5			
T <sub>d(on)</sub>	Turn-On Delay Time			1.6			
Tr	Rise Time	$V_{DD}$ =10V , $V_{GS}$ =4.5V , $R_{G}$ =3.3 $\Omega$		42			
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =3A		14		ns	
Tf	Fall Time			7			
C <sub>iss</sub>	Input Capacitance			310			
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		49		pF	
Crss	Reverse Transfer Capacitance			35			

#### **Diode Characteristics**

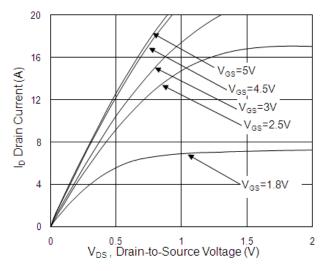
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current	-		3.6	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V

#### Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\,\leq\,300\text{us}$  , duty cycle  $\,\leq\,2\%$
- 3.The power dissipation is limited by 150°C junction temperature
- 4. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



## **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

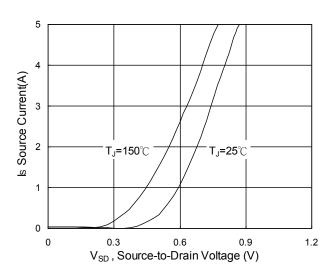


Fig.3 Forward Characteristics of Reverse

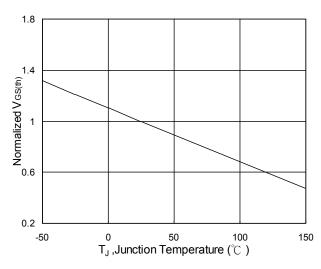


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

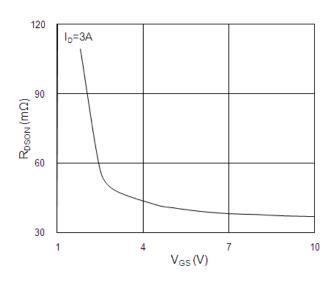
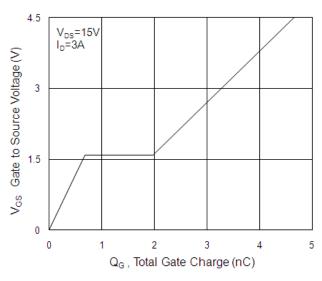


Fig.2 On-Resistance vs. Gate-Source Voltage



**Fig.4 Gate-Charge Characteristics** 

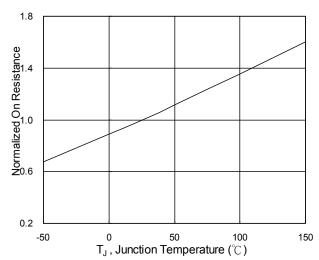
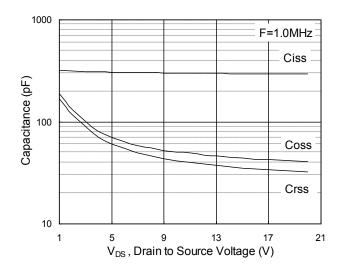


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>





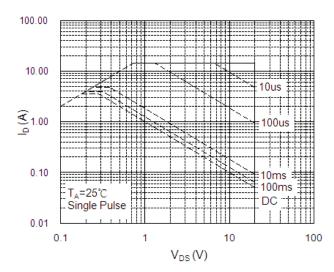


Fig.7 Capacitance

Fig.8 Safe Operating Area

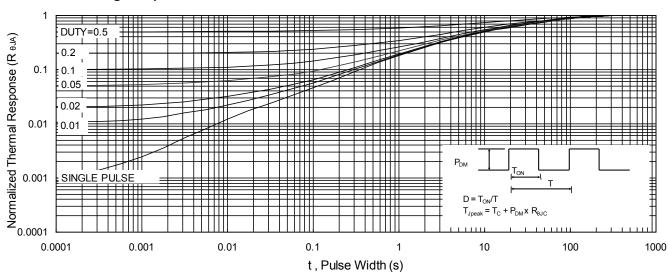
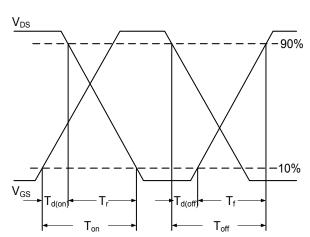


Fig.9 Normalized Maximum Transient Thermal Impedance





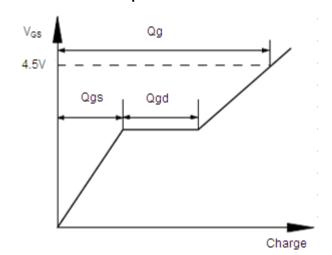
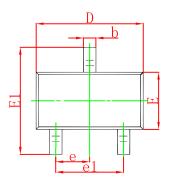
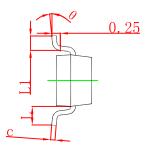


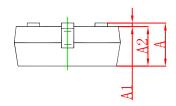
Fig.11 Gate Charge Waveform



# **SOT-23 Package Outline Dimensions**

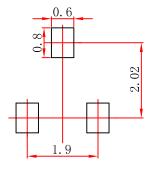






Symbol	Dimensions In Millimeters		Dimensions In Inches		
Зупроі	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550	) REF	EF 0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

# **SOT-23 Suggested Pad Layout**



#### Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.



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